SWITCHMODE™ Soft Recovery Power Rectifier

Designed for boost converter or hard-switched converter applications, especially for Power Factor Correction application. It could also be used as a free wheeling diode in variable speed motor control applications and switching mode power supplies. These state-of-the-art devices have the following features:

- Soft Recovery with Low Reverse Recovery Charge (Q_{RR}) and Peak Reverse Recovery Current (I_{RRM})
- 150°C Operating Junction Temperature
- Popular TO-220 Package
- Epoxy meets UL94, V_O @ 1/8"
- Low Forward Voltage
- Low Leakage Current
- High Temperature Glass Passivated Junction

Mechanical Characteristics:

- Case: Molded Epoxy
- Weight: 1.9 Grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 50 Units per Plastic Tube
- Marking: MSR1560

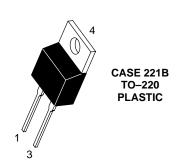


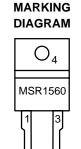
ON Semiconductor

http://onsemi.com

SOFT RECOVERY POWER RECTIFIER 15 AMPERES 600 VOLTS







ORDERING INFORMATION

Device	Package	Shipping		
MSR1560	TO-220	50 Units/Rail		

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	600	V
Average Rectified Forward Current (At Rated V _R , T _C = 125°C)	Io	15	Α
Peak Repetitive Forward Current (At Rated V _R , Square Wave, 20 kHz, T _C = 125°C)	I _{FRM}	30	А
Non–Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)		100	А
Storage / Operating Case Temperature	T _{stg} , T _C	- 65 to 150	°C
Operating Junction Temperature	TJ	- 65 to 150	°C

THERMAL CHARACTERISTICS

Thermal Resistance — Junction–to–Case	$R_{\theta JC}$	1.6	°C/W
Thermal Resistance — Junction–to–Ambient	$R_{\theta JA}$	72.8	

ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (Note 1.) (I _F = 15 A)	V _F	T _J = 25°C	T _J = 150°C	V
Typical		1.8 <i>1.5</i>	1.4 1.2	
Maximum Instantaneous Reverse Current (V _R = 600 V)	I _R	T _J = 25°C	T _J = 150°C	μΑ
Typical		15 <i>0.4</i>	5000 100	
Maximum Reverse Recovery Time (Note 2.) ($V_R = 30 \text{ V}$, $I_F = 1 \text{ A}$, $di/dt = 100 \text{ A/}\mu\text{s}$)	t _{rr}	T _J = 25°C	T _J = 100°C	ns
Typical		45 <i>35</i>	65 <i>54</i>	
Typical Recovery Softness Factor (V _R = 30 V, I _F = 1 A, di/dt = 100 A/μs)	$s = t_b/t_a$.67	.74	
Typical Peak Reverse Recovery Current (V _R = 30 V, I _F = 1 A, di/dt = 100 A/μs)	I _{RRM}	2.3	3.2	Α
Typical Reverse Recovery Charge ($V_R = 30 \text{ V}, I_F = 1 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$)	Q_{RR}	31	78	nC

Pulse Test: Pulse Width ≤ 380 μs, Duty Cycle ≤ 2%
 T_{RR} measured projecting from 25% of I_{RRM} to zero current

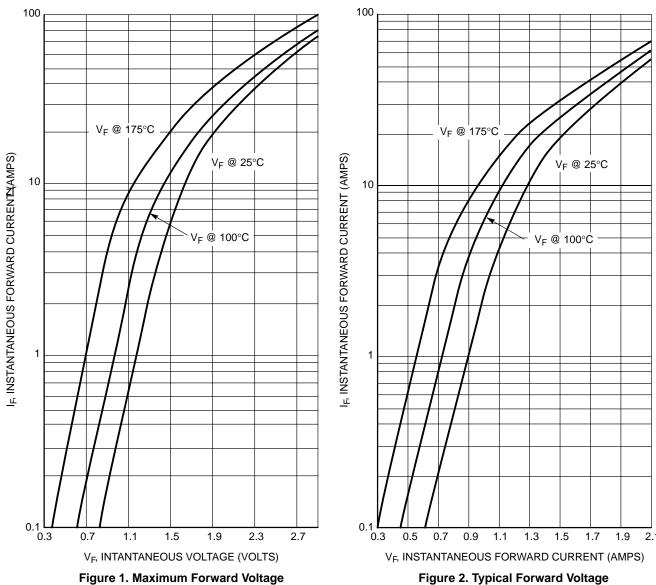


Figure 1. Maximum Forward Voltage

V_F @ 100°C

200

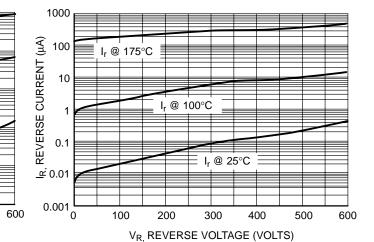
V_F @ 175°C

10000

IR, REVERSE CURRENT (µA)

0.1

100



V_R, REVERSE VOLTAGE (VOLTS) Figure 3. Maximum Reverse Current

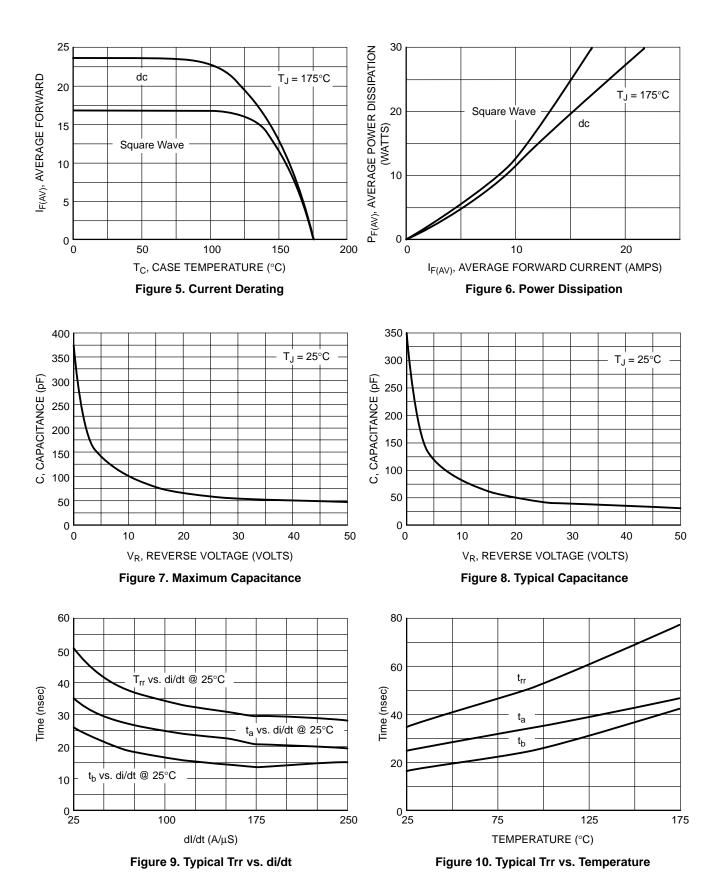
300

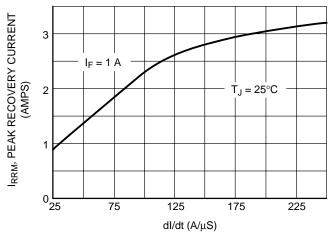
V_F @ 25°C

400

500

Figure 4. Typical Reverse Current





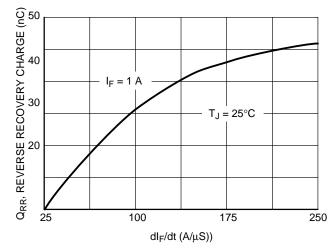


Figure 11. Typical Peak Reverse Recovery Current

Figure 12. Typical Reverse Recovery Charge

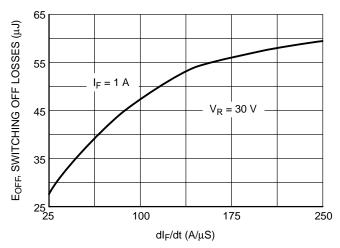


Figure 13. Typical Switching Off Losses

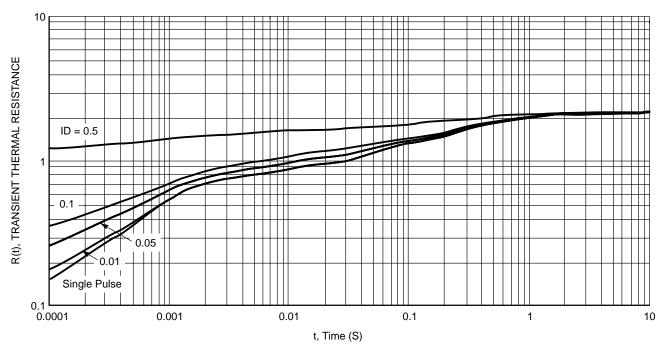
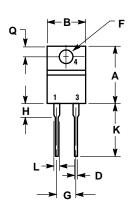
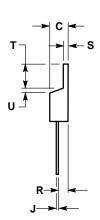


Figure 14. Transient Thermal Response

PACKAGE DIMENSIONS

TO-220 **PLASTIC** CASE 221B-04 ISSUE D





- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.595	0.620	15.11	15.75
В	0.380	0.405	9.65	10.29
С	0.160	0.190	4.06	4.82
D	0.025	0.035	0.64	0.89
F	0.142	0.147	3.61	3.73
G	0.190	0.210	4.83	5.33
Н	0.110	0.130	2.79	3.30
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.14	1.52
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.14	1.39
Т	0.235	0.255	5.97	6.48
U	0.000	0.050	0.000	1.27

STYLE 1: PIN 1. CATHODE 2. N/A 3. ANODE 4. CATHODE

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